



SamHop Microelectronics Corp.



# STS3405

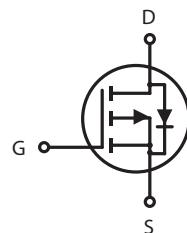
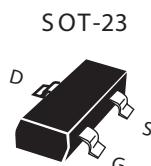
Ver 1.1

## P-Channel Enhancement Mode Field Effect Transistor

PRODUCT SUMMARY		
VDSS	ID	RDS(ON) (mΩ) Max
-30V	-3A	100 @ VGS=-10V
		150 @ VGS=-4.5V

### FEATURES

- Super high dense cell design for low RDS(ON).
- Rugged and reliable.
- SOT-23 package.



### ABSOLUTE MAXIMUM RATINGS ( $T_A=25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter		Limit	Units
$V_{DS}$	Drain-Source Voltage		-30	V
$V_{GS}$	Gate-Source Voltage		$\pm 20$	V
$I_D$	Drain Current-Continuous <sup>a</sup>	$T_A=25^\circ\text{C}$	-3	A
		$T_A=70^\circ\text{C}$	-2.4	A
$I_{DM}$	-Pulsed <sup>b</sup>		-12	A
$P_D$	Maximum Power Dissipation <sup>a</sup>	$T_A=25^\circ\text{C}$	1.25	W
		$T_A=70^\circ\text{C}$	0.8	W
$T_J, T_{STG}$	Operating Junction and Storage Temperature Range		-55 to 150	$^\circ\text{C}$

### THERMAL CHARACTERISTICS

$R_\theta JA$	Thermal Resistance, Junction-to-Ambient <sup>a</sup>	100	$^\circ\text{C/W}$
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## ELECTRICAL CHARACTERISTICS ( $T_A=25^\circ C$ unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Units
<b>OFF CHARACTERISTICS</b>						
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> =0V, I <sub>D</sub> =-250μA	-30			V
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> =-24V, V <sub>GS</sub> =0V			1	μA
I <sub>GSS</sub>	Gate-Body Leakage Current	V <sub>GS</sub> = ±20V, V <sub>DS</sub> =0V			±100	nA
<b>ON CHARACTERISTICS</b>						
V <sub>GS(th)</sub>	Gate Threshold Voltage	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =-250μA	-1	-1.5	-3	V
R <sub>D(S(ON))</sub>	Drain-Source On-State Resistance	V <sub>GS</sub> =-10V, I <sub>D</sub> =-3A		80	100	m ohm
		V <sub>GS</sub> =-4.5V, I <sub>D</sub> =-2.4A		115	150	m ohm
g <sub>FS</sub>	Forward Transconductance	V <sub>DS</sub> =-5V, I <sub>D</sub> =-3A		8		S
<b>DYNAMIC CHARACTERISTICS</b> <sup>c</sup>						
C <sub>ISS</sub>	Input Capacitance	V <sub>DS</sub> =-15V, V <sub>GS</sub> =0V f=1.0MHz		435		pF
C <sub>OSS</sub>	Output Capacitance			90		pF
C <sub>RSS</sub>	Reverse Transfer Capacitance			60		pF
<b>SWITCHING CHARACTERISTICS</b> <sup>c</sup>						
t <sub>D(ON)</sub>	Turn-On Delay Time	V <sub>DD</sub> =-15V I <sub>D</sub> =-1A V <sub>GS</sub> =-10V R <sub>GEN</sub> =6 ohm		8		ns
t <sub>r</sub>	Rise Time			6.8		ns
t <sub>D(OFF)</sub>	Turn-Off Delay Time			37		ns
t <sub>f</sub>	Fall Time			13		ns
Q <sub>g</sub>	Total Gate Charge	V <sub>DS</sub> =-15V, I <sub>D</sub> =-3A, V <sub>GS</sub> =-10V		7.8		nC
Q <sub>gs</sub>	Gate-Source Charge			0.58		nC
Q <sub>gd</sub>	Gate-Drain Charge			2.2		nC
<b>DRAIN-SOURCE DIODE CHARACTERISTICS AND MAXIMUM RATINGS</b>						
I <sub>s</sub>	Maximum Continuous Drain-Source Diode Forward Current			-1.25		A
V <sub>SD</sub>	Diode Forward Voltage <sup>b</sup>	V <sub>GS</sub> =0V, I <sub>s</sub> =-1.25A		-0.8	-1.25	V

### Notes

- a.Surface Mounted on FR4 Board,t ≤ 10sec.
- b.Pulse Test:Pulse Width ≤ 300us, Duty Cycle ≤ 2%.
- c.Guaranteed by design, not subject to production testing.

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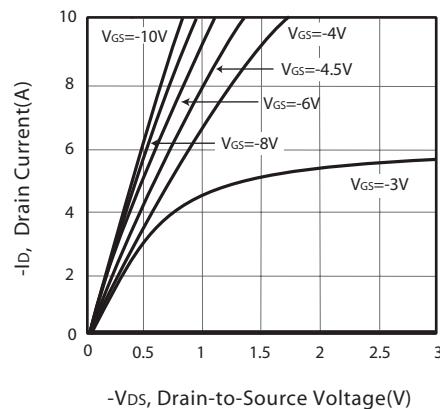


Figure 1. Output Characteristics

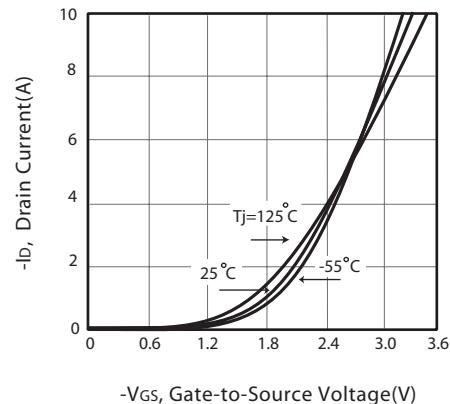


Figure 2. Transfer Characteristics

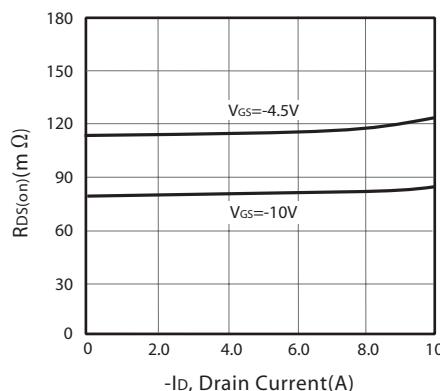


Figure 3. On-Resistance vs. Drain Current and Gate Voltage

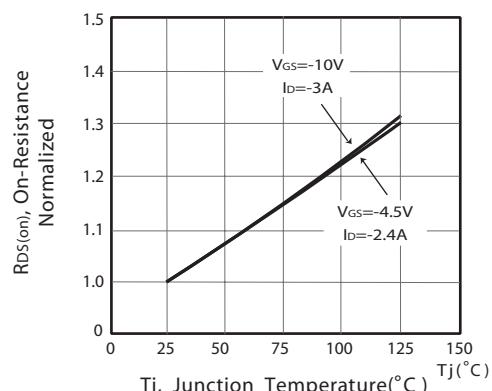


Figure 4. On-Resistance Variation with Drain Current and Temperature

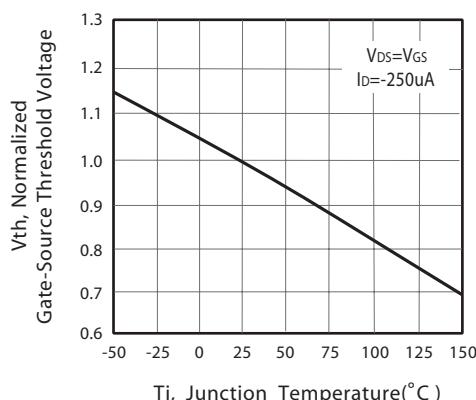


Figure 5. Gate Threshold Variation with Temperature

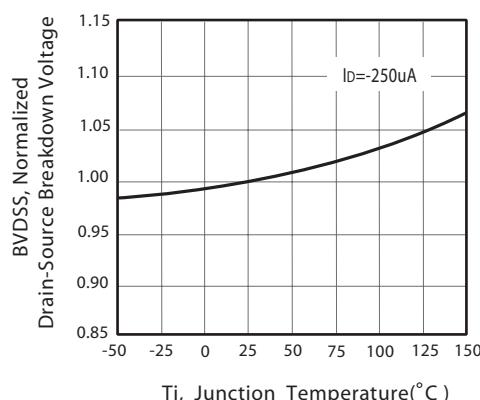


Figure 6. Breakdown Voltage Variation with Temperature

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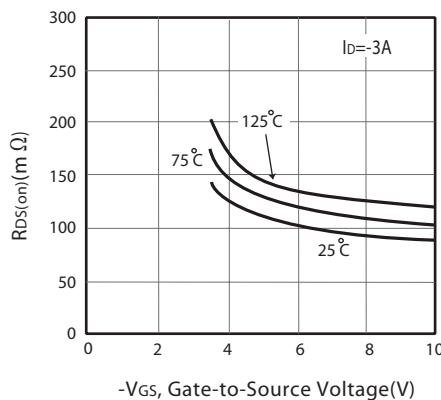


Figure 7. On-Resistance vs. Gate-Source Voltage

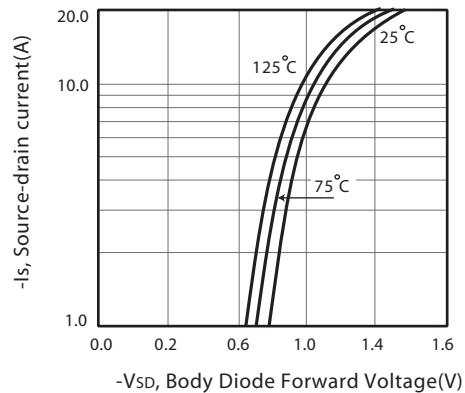


Figure 8. Body Diode Forward Voltage Variation with Source Current

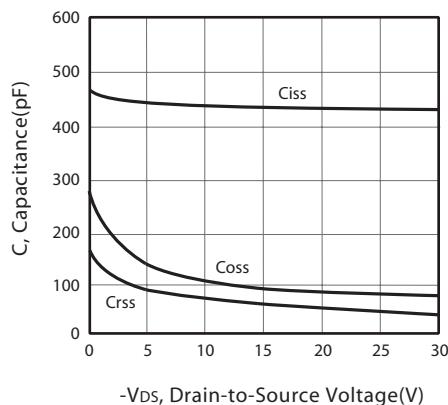


Figure 9. Capacitance

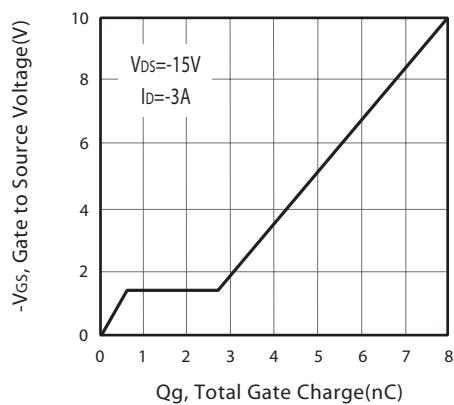


Figure 10. Gate Charge

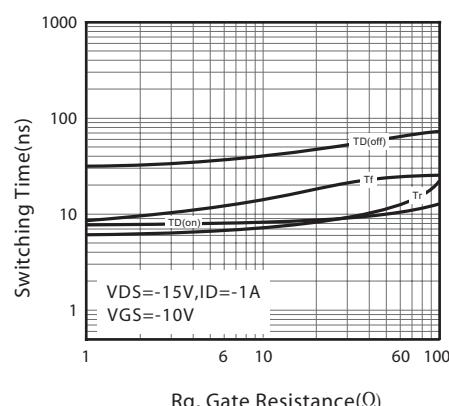


Figure 11. switching characteristics

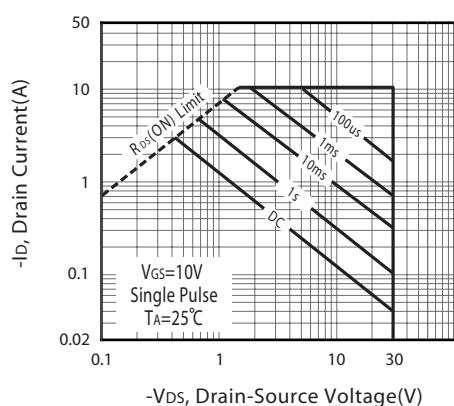


Figure 12. Maximum Safe Operating Area

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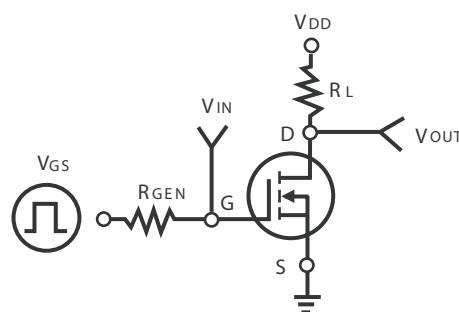


Figure 13. Switching Test Circuit

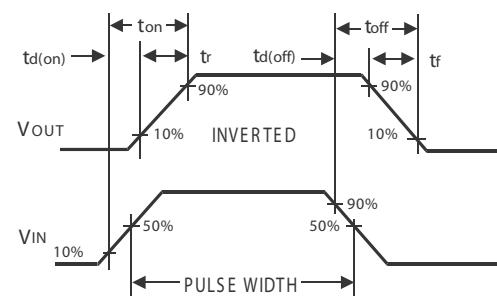
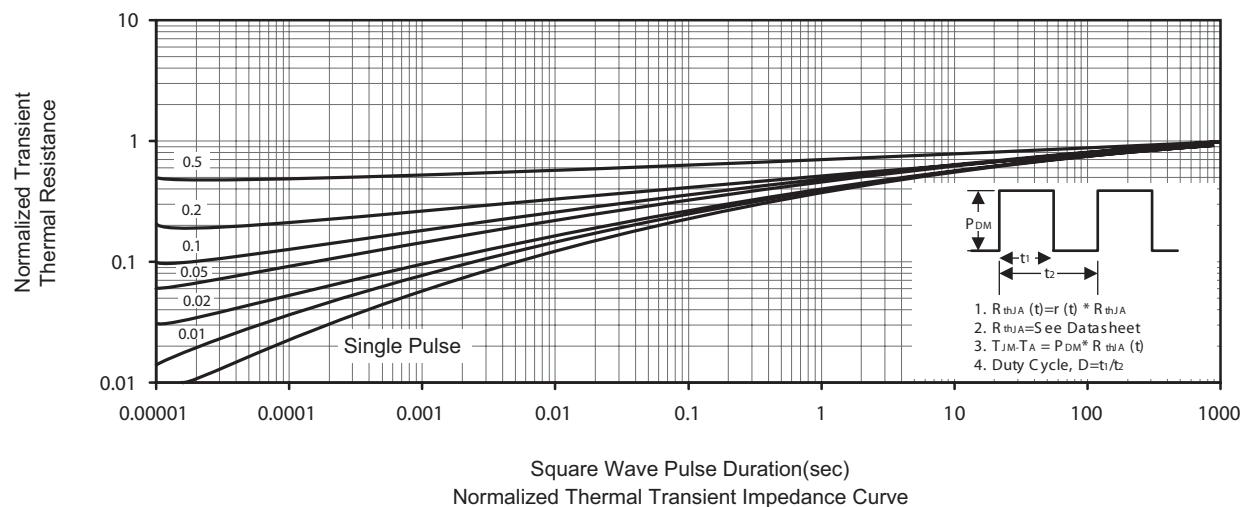


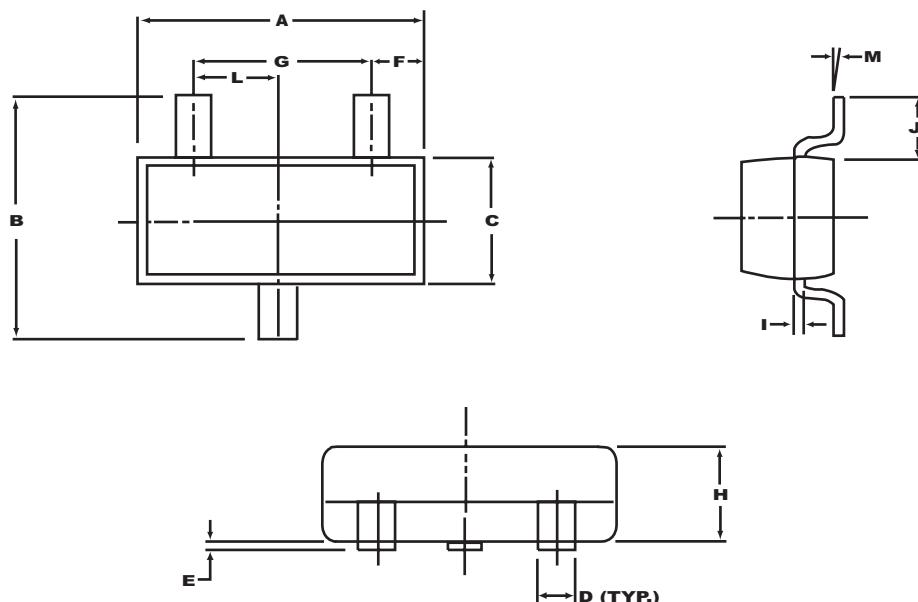
Figure 14. Switching Waveforms



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## PACKAGE OUTLINE DIMENSIONS

SOT 23



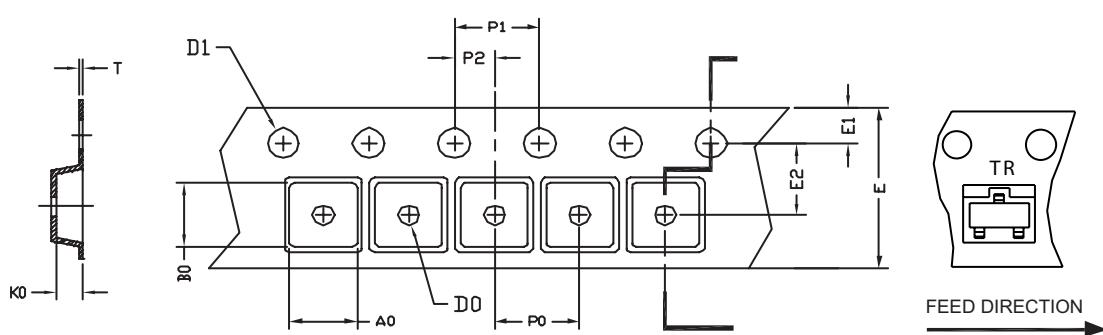
SYMBOLS	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	2.70	3.10	0.106	0.122
B	2.40	2.80	0.094	0.110
C	1.40	1.60	0.055	0.063
D	0.35	0.50	0.014	0.020
E	0	0.10	0	0.004
F	0.45	0.55	0.018	0.022
G	1.90 REF.		0.075 REF.	
H	1.00	1.30	0.039	0.051
I	0.10	0.20	0.004	0.008
J	0.40	-	0.016	-
L	0.45	1.15	0.033	0.045
M	0°	10°	0°	10°

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## SOT-23 Tape and Reel Data

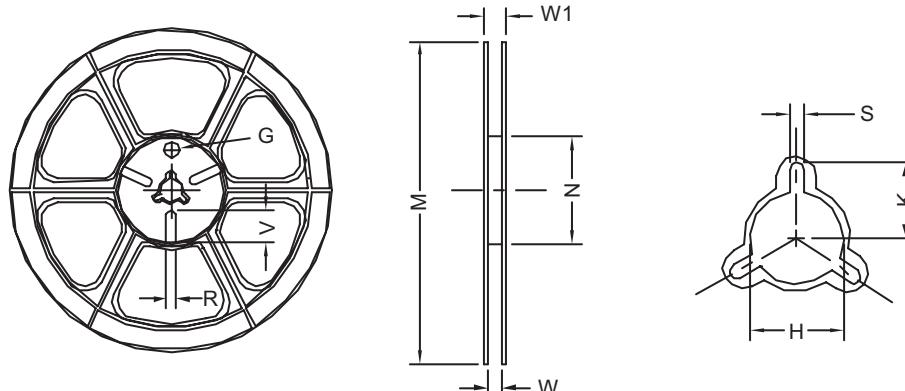
### SOT-23 Carrier Tape



UNIT:mm

PACKAGE	A0	B0	K0	D0	D1	E	E1	E2	P0	P1	P2	T
SOT-23	3.20 ±0.10	3.00 ±0.10	1.33 ±0.10	§ 1.00 +0.25	§ 1.50 +0.10	8.00 +0.30 -0.10	1.75 ±0.10	3.50 ±0.05	4.00 ±0.10	4.00 ±0.10	2.00 ±0.05	0.20 ±0.02

### SOT-23 Reel



UNIT:mm

TAPE SIZE	REEL SIZE	M	N	W	W1	H	K	S	G	R	V
8mm	§ 178	§ 178 ±1	§ 60 ±1	9.00 ±0.5	12.00 ±0.5	§ 13.5 ±0.5	10.5	2.00 ±0.5	§ 10.0	5.00	18.00

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